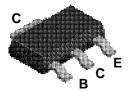


Discrete Power & Signal Technologies

July 1998

FZT649



SOT-223

NPN Low Saturation Transistor

These devices are designed with high current gain and low saturation voltage with collector currents up to 3A continuous.

Absolute Maximum Ratings* T_{A = 25°C unless otherwise noted}

| Symbol | Parameter | FZT649 | Units |
|-----------------------------------|--|-------------|-------|
| V _{CEO} | Collector-Emitter Voltage | 25 | V |
| V _{CBO} | Collector-Base Voltage | 35 | V |
| V _{EBO} | Emitter-Base Voltage | 5 | V |
| Ic | Collector Current - Continuous | 3 | А |
| T _J , T _{stg} | Operating and Storage Junction Temperature Range | -55 to +150 | °C |

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150°C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics $T_{A=25^{\circ}\text{C unless otherwise noted}}$

| Symbol | Characteristic | Max | Units |
|-----------------|---|--------|-------|
| | | FZT649 | |
| P _D | Total Device Dissipation | 2 | W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 62.5 | °C/W |

NPN Low Saturation Transistor

(continued)

Electrical Characteristics

 $T_{\text{A}\,=\,25^{\circ}\text{C}\,\text{unless otherwise noted}}$

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|----------------------|--------------------------------------|---|-----|------|-------|
| OFF CHA | RACTERISTICS | | | | |
| BV _{CEO} | Collector-Emitter Breakdown Voltage | I _C = 10 mA | 25 | | V |
| BV _{CBO} | Collector-Base Breakdown Voltage | I _C = 100 μA | 35 | | V |
| BV _{EBO} | Emitter-Base Breakdown Voltage | I _E = 100 μA | 5 | | V |
| I _{CBO} | Collector Cutoff Current | V _{CB} = 30 V | | 100 | nA |
| | | $V_{CB} = 30 \text{ V}, T_A = 100^{\circ}\text{C}$ | | 10 | uA |
| I _{EBO} | Emitter Cutoff Current | V _{EB} = 4V | | 100 | nA |
| ON CHAF | ACTERISTICS* | | | | |
| h _{FE} | DC Current Gain | $I_C = 50 \text{ mA}, V_{CE} = 2 \text{ V}$ | 70 | | - |
| | | I _C = 1 A, V _{CE} = 2 V | 100 | 300 | |
| | | $I_C = 2 A$, $V_{CE} = 2 V$ | 75 | | |
| | | I _C = 6 A, V _{CE} = 2 V | 15 | | |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | I _C = 1 A, I _B = 100 mA | | 300 | mV |
| | | I _C = 3 A, I _B = 300 mA | | 600 | |
| V _{BE(sat)} | Base-Emitter Saturation Voltage | I _C = 1 A, I _B = 100 mA | | 1.25 | V |
| V _{BE(on)} | Base-Emitter On Voltage | I _C = 1 A, V _{CE} = 2 V | | 1 | V |
| SMALL S | IGNAL CHARACTERISTICS | | | | |
| C _{obo} | Output Capacitance | V _{CB} = 10 V, I _E = 0, f = 1MHz | | 50 | pF |
| f _T | Transition Frequency | I _C = 100 mA,V _{CE} = 5 V, f=100MHz | 150 | | - |

*Pulse Test: Pulse Width $\leq 300~\mu s,~Duty~Cycle \leq 2.0\%$

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PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|---------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
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